



Designed for Solution Engineered to Last



HSG DRYING FURNACE

Applications

- Drying and curing of thick film circuit, paste on SMD terminal, etc.
- Silicon solar cell, thin film solar cell, and dye sensitized solar cell processing.
- Epoxy curing, encapsulation, underfill curing, chip joining and die bonding.

Highlights

- Infrared Heating
- Customized Belt Size and Clearance
- Belt Speed Control
- Type K Thermocouple Standard
- Independent Over-Temperature Control in Each Zone
- $\pm 2^{\circ}\text{C}$ Cross Belt Uniformity
- Active Cooling
- Forced Exhaust System
- Custom Voltage Configurations
- Custom Temperature Profiling
- Free Shipping and Delivery